2ED020I06-FI

Dual IGBT Driver IC

April 2000

Power Managment & Drives



2ED020I06-FI Revision History: 2010-04-20 Datasheet

| Previous V | Previous Version: | | | | | | |
|------------|--|--|--|--|--|--|--|
| Page | Subjects (major changes since last revision) | | | | | | |
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Dual IGBT Driver IC 2ED020I06-FI

Product Highlights

- Fully operational to $\pm 650V$
- Power supply operating range from 14 to 18 V
- Gate drive currents of +1 A / -2 A
- Matched propagation delay for both channels
- High dV/dt immunity
- · Low power consumption

Features

- · Floating high side driver
- · Undervoltage lockout for both channels
- 3.3 V and 5 V TTL compatible inputs
- · CMOS Schmitt-triggered inputs with pull-down
- Non-inverting inputs
- · Interlocking inputs
- · Dedicated shutdown input with pull-up
- · RoHS compliant



PG-DS O-18-2

| Туре | Ordering Code | Package | Packaging |
|--------------|---------------|-------------|-----------|
| 2ED020I06-FI | | PG-DSO-18-2 | Tape&Reel |



Overview

1 Overview

The 2ED020I06-FI is a high voltage, high speed power MOSFET and IGBT driver with interlocking high and low side referenced outputs. The floating high side driver may be supplied directly or by means of a bootstrap diode and capacitor. In addition to the logic input of each driver the 2ED020I06-FI is equipped with a dedicated shutdown input. All logic inputs are compatible with 3.3 V and 5 V TTL. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. Both drivers are designed to drive an N-channel power MOSFET or IGBT which operate up to 650V.



Pin Configuration and Functionality

2 Pin Configuration and Functionality

2.1 Pin Configuration

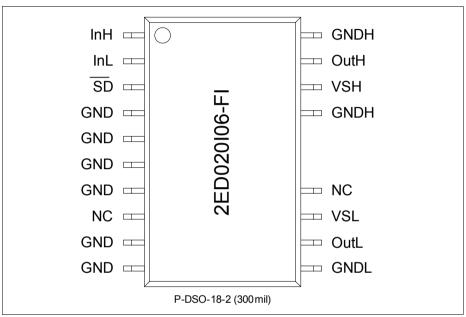


Figure 1 Pin Configuration (top view)

2.2 Pin Definitions and Functions

| Pin | Symbol | Function |
|-----|--------|--|
| 1 | InH | Logic input for high side driver |
| 2 | InL | Logic input for low side driver |
| 3 | SD | Logic input for shutdown of both drivers |
| 4 | GND | Common ground |
| 5 | GND | Connect to GND |
| 6 | GND | Connect to GND |
| 7 | GND | Connect to GND |
| 8 | n.c. | Do not connect, Pin must stay open |

Table 1 Pin Description



High and Low Side Driver 2ED020I06-FI

Pin Configuration and Functionality

| Pin | Symbol | Function |
|-----|--------|------------------------------|
| 9 | GND | Connect to GND |
| 10 | GND | Connect to GND |
| 11 | GNDL | Low side power ground 1) |
| 12 | OutL | Low side gate driver output |
| 13 | VSL | Low side supply voltage |
| 14 | n.c. | (not connected) |
| 15 | n.e. | (not existing) |
| 16 | n.e. | (not existing) |
| 17 | GNDH | High side (power) ground |
| 18 | VSH | High side supply voltage |
| 19 | OutH | High side gate driver output |
| 20 | GNDH | High side (power) ground |

Table 1 Pin Description (cont'd)

¹⁾ Please note: GNDL has to be connected directly to GND



Block Diagram

3 Block Diagram

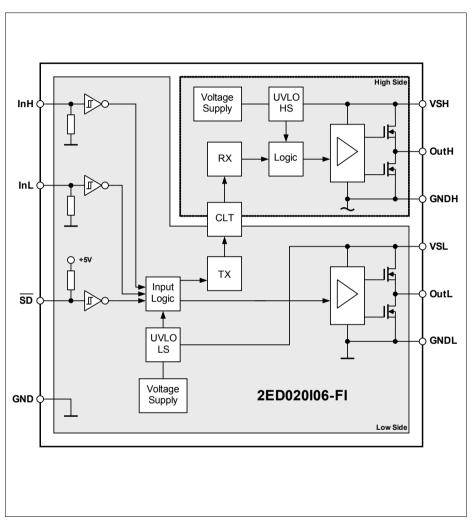


Figure 2 Block Diagram



Functional Description

4 Functional Description

4.1 Power Supply

The power supply of both sides, "VSL" and "VSH", is monitored by an undervoltage lockout block (UVLO) which enables operation of the corresponding side when the supply voltage reaches the "on" threshold. Afterwards the internal voltage reference and the biasing circuit are enabled. When the supply voltage (VSL, VSH) drops below the "off" threshold, the circuit is disabled.

4.2 Logic Inputs

The logic inputs InH, InL and \overline{SD} are fed into Schmitt-Triggers with thresholds compatible to 3.3V and 5V TTL. When \overline{SD} is enabled (low), InH and InL are disabled. If InH is high (while InL is low), OutH is enabled and vice versa. However, if both signals are high, they are internally disabled until one of them gets low again. This is due to the interlocking logic of the device. See Figure 3 (section 4.7).

4.3 Gate Driver

2ED020I06-FI features two hard-switching gate drivers with N-channel output stages capable to source 1A and to sink 2A peak current. Both drivers are equipped with active-low-clamping capability. Furthermore, they feature a large ground bounce ruggedness in order to compensate ground bounces caused by a turn-off of the driven IGBT.

4.4 Coreless Transformer (CLT)

In order to enable signal transmission across the isolation barrier between low-side and high-side driver, a transformer based on CLT-Technology is employed. Signals, that are to be transmitted, are specially encoded by the transmitter and correspondingly restored by the receiver. In this way EMI due to variations of GNDH (dV_{GNDH}/dt) or the magnetic flux density (dH/dt) can be suppresed. To compensate the additional propagation delay of transmitter, level shifter and receiver, a dedicated propagation delay is introduced into the low-side driver.



Functional Description

4.5 Diagrams

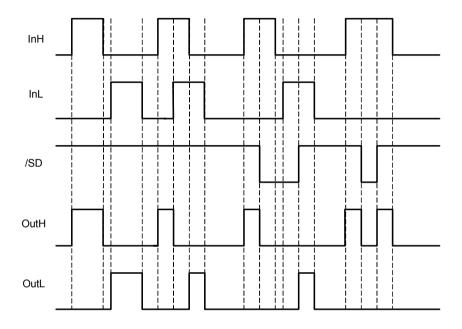


Figure 3 Input/Output Timing Diagram



Electrical Parameters

5 Electrical Parameters

5.1 Absolute Maximum Ratings

Note: Absolute maximum ratings are defined as ratings, which when being exceeded may lead to destruction of the integrated circuit. Unless otherwise noted all parameters refer to GND.

| Parameter | Symbol | Limit | Values | Unit | Remarks | |
|---|------------------------|-------|-----------|------|-----------------------------------|--|
| | | min. | max. | | | |
| High side ground | GNDH | -650 | 650 | V | | |
| High side supply voltage | VSH | -0.3 | 20 | V | 1) | |
| High side gate driver output | OutH | -0.3 | VSH + 0.3 | V | 1) | |
| Low side ground | GNDL | -0.3 | 5.3 | V | | |
| Low side supply voltage | VSL | -0.3 | 20 | V | 2) | |
| Low side gate driver output | OutL | -0.3 | VSL + 0.3 | V | 3) | |
| Logic input voltages (InH, InL, \overline{SD}) | V _{IN} | -0.3 | 5.3 | V | | |
| High side ground, voltage transient | dV _{GNDH} /dt | -50 | 50 | V/ns | | |
| ESD Capability | V _{ESD} | _ | 2 | kV | ⁴⁾ Human Body Model | |
| Package power disipation @T _A = 25°C | P_{D} | _ | 1.4 | W | 5) | |
| Thermal resistance (both chips active), junction to ambient | R _{THJA} | _ | 90 | K/W | 6) | |
| Thermal resistance (high side chip), junction to ambient | R _{THJA(HS)} | _ | 110 | K/W | 6) | |
| Thermal resistance (low side chip), junction to ambient | R _{THJA(LS)} | _ | 110 | K/W | 6) | |
| Junction temperature | T_{J} | _ | 150 | °C | | |
| Storage temperature | T_S | -55 | 150 | °C | | |

¹⁾ With reference to high side ground GNDH.

²⁾ With respect to both GND and GNDL.

³⁾ With respect to GNDL.

⁴⁾ According to EIA/JESD22-A114-B (discharging a 100pF capacitor through a $1.5 \mathrm{k}\Omega$ series resistor).

⁵⁾ Considering Rth(both chips active)=90K/W

High and Low Side Driver 2ED020106-FI

Electrical Parameters

5.2 Operating Range

Note: Within the operating range the IC operates as described in the functional description. Unless otherwise noted all parameters refer to GND.

| Parameter | Symbol | Liı | mit Values | Unit | Remarks |
|--|-----------------|------|------------|------|---|
| | | min. | max. | | |
| High side ground | GNDH | -650 | 650 | V | |
| High side supply voltage | VSH | 14 | 18 | V | 1) |
| Low side supply voltage | VSL | 14 | 18 | V | 2) |
| Logic input voltages (InH, InL, \$\overline{SD}\$) | V _{IN} | 0 | 5 | V | |
| Junction temperature | T_{J} | -40 | 105 | °C | Industrial applications, useful lifetim 87600h |
| Junction temperature | T_{J} | -40 | 125 | °C | Other applications, useful lifetim 15000h |

¹⁾ With reference to high side ground GNDH.

5.3 Electrical Characteristics

Note: The electrical characteristics involve the spread of values for the supply voltages, load and junction temperature given below. Typical values represent the median values, which are related to production processes. Unless otherwise noted all voltages are given with respect to ground (GND). VSL = VSH - GNDH = 15V, $C_L = 1nF$, $T_A = 25\,^{\circ}C$. Positive currents are assumed to be flowing into pins.

Voltage Supply

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|---------------------------|------------|--------------|-----|------|------|---------------------------|
| | | min. | typ | max. | | |
| High side leakage current | I_{GNDH} | _ | 0 | | μΑ | GNDH = 1.2kV GNDL = 0V |

⁶⁾ Device soldered to reference PCB without cooling area

²⁾ With respect to both GND and GNDL.

High and Low Side Driver 2ED020I06-FI

Electrical Parameters

Voltage Supply (cont'd)

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|---|--------------------------------|--------------|------|------|------|--|
| | | min. | typ | max. | | |
| High side quiescent supply | I_{VSH} | _ | 2.4 | 3.2 | mA | $VSH = 15V^{1)}$ |
| current | | _ | 2.3 | 3.2 | mA | $VSH = 15 V^{1}$ $T_J = 125 ^{\circ}C$ |
| High side undervoltage lockout, upper threshold | V _{VSH} ¹⁾ | 10.9 | 12.2 | 13.5 | V | |
| High side undervoltage lockout, lower threshold | V _{VSH} ¹⁾ | _ | 11.2 | _ | V | |
| High side undervoltage lockout hysteresis | ΔV_{VSH} | 0.7 | 1 | 1.3 | V | |
| Low side quiescent supply | I_{VSL} | _ | 3.9 | 5.0 | mA | VSL = 15 V |
| current | | | 3.9 | 5.5 | mA | $VSL = 15 V$ $T_{J} = 125 \text{ °C}$ |
| Low side undervoltage lockout, upper threshold | V _{VSL} | 10.7 | 12 | 13.3 | V | |
| Low side undervoltage lockout, lower threshold | V _{VSL} | _ | 11 | _ | V | |
| Low side undervoltage lockout hysteresis | ΔV_{VSL} | 0.7 | 1 | 1.3 | V | |

¹⁾ With reference to high side ground GNDH.

Logic Inputs

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|---|-----------------|--------------|-----|------|------|-----------------------|
| | | min. | typ | max. | | |
| Logic "1" input voltages (InH, InL, \overline{SD}) | V _{IN} | 2 | _ | _ | V | |
| Logic "0" input voltages (InH, InL, \overline{SD}) | V _{IN} | _ | | 0.8 | V | |
| Logic "1" input currents (InH, InL) | I _{IN} | _ | 40 | 55 | μΑ | $V_{IN} = 5 V$ |
| Logic "0" input currents (InH, InL) | I_{IN} | _ | 0 | _ | μΑ | $V_{IN} = 0 V$ |



Electrical Parameters

Logic Inputs (cont'd)

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|-------------------------------|-----------------|--------------|-----|------|------|-----------------------|
| | | min. | typ | max. | | |
| Logic "1" input currents (SD) | I _{IN} | _ | 0 | _ | μΑ | $V_{IN} = 5 V$ |
| Logic "0" input currents (SD) | I _{IN} | -60 | -40 | _ | μΑ | $V_{IN} = 0 V$ |

Gate Drivers

| Parameter | Symbol | L | imit Val | ues | Unit | Test Condition |
|---------------------------------------|---|------|----------|------|------|--|
| | | min. | typ | max. | | |
| High side high level output voltage | $\begin{matrix} V_{VSH} - \\ V_{OutH} \end{matrix}$ | _ | 1.4 | 1.7 | V | $I_{OutH} = -1mA$ $V_{InH} = 5V$ |
| High side low level output voltage | V _{OutH} ¹⁾ | _ | _ | 0.1 | V | $I_{OutH} = 1mA$ $V_{InH} = 0V$ |
| Low side high level output voltage | $V_{VSL} - V_{OutL}$ | _ | 1.4 | 1.7 | V | $I_{OutL} = -1 \text{ mA}$ $V_{InL} = 5 \text{ V}$ |
| Low side low level output voltage | V_{OutL} | _ | _ | 0.1 | V | $I_{OutL} = 1mA$ $V_{InL} = 0V$ |
| Output high peak current (OutL, OutH) | I_{Out} | _ | _ | -1 | A | $V_{IN} = 5 V$ $V_{Out} = 0 V$ |
| Output low peak current (OutL, OutH) | I_{Out} | 2 | _ | _ | A | $V_{IN} = 0V$ $V_{Out} = 15V$ |
| High side active low clamping | V _{OutH} ¹⁾ | _ | 2.6 | 3 | V | InH =0V, VSH open I _{OutH} =200mA |
| | | | 2.7 | 3.2 | V | InH =0V, VSH open I_{OutH} =200mA T_{J} = 125 °C |
| Low side active low clamping | V _{OutL} | _ | 2.6 | 3 | V | InL =0V, VSL open I _{OutL} =200mA |
| | | _ | 2.7 | 3.2 | V | InL =0V, VSL open I_{OutL} =200mA T_J = 125 °C |

¹⁾ With reference to high side ground GNDH.

High and Low Side Driver 2ED020I06-FI

Electrical Parameters

Dynamic Characteristics

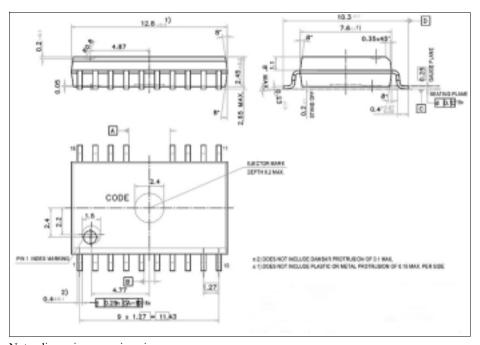
| Parameter | Symbol | I | imit Va | alues | Unit | Test Condition |
|--|-------------------|------|---------|-------|------|---|
| | | min. | typ | max. | | |
| Turn-on propagation delay | t _{ON} | _ | 85 | 105 | ns | $GNDH = 0V$ $20\% V_{out}$ |
| | | _ | 95 | 120 | ns | $GNDH = 0V$ $20\% V_{out}$ $T_{J} = 125 °C$ |
| Turn-off propagation delay | t _{OFF} | _ | 85 | 115 | ns | 80% V _{out} |
| | | _ | 100 | 130 | ns | $80\% V_{out}$ $T_{J} = 125 \text{ °C}$ |
| Shutdown propagation | $t_{\rm SD}$ | _ | 85 | 115 | ns | 80% V _{out} |
| delay | | _ | 100 | 130 | ns | $80\% V_{out}$ $T_{J} = 125 \text{ °C}$ |
| Turn-on rise time | t _r | _ | 20 | 40 | ns | 20% to 80% V _{out} |
| | | _ | 30 | 50 | ns | $20\% \text{ to } 80\% \text{ V}_{\text{out}}$ $T_{\text{J}} = 125 \text{ °C}$ |
| Turn-off fall time | $t_{\rm f}$ | _ | 20 | 35 | ns | 80% to 20% V _{out} |
| | | _ | 25 | 40 | ns | $80\% \text{ to } 20\% \text{ V}_{\text{out}}$ $T_J = 125 \text{ °C}$ |
| Delay mismatch (high & low side turn-on/off) | Δt | _ | 15 | 25 | ns | $T_J = 25^{\circ}C$ see Figure 6 |
| | | _ | 15 | 30 | ns | $T_J = 125$ °C see Figure 6 |
| Minimum turn-on input | t_{pON} | _ | 50 | 75 | ns | 1) |
| (InH, InL) pulse width | | _ | 55 | 80 | ns | $^{1)}T_{J} = 125^{\circ}C$ |
| Minimum turn-off input | t _{pOFF} | _ | 50 | 75 | ns | 1) |
| (InH, InL) pulse width | | _ | 55 | 80 | ns | $^{1)}$ T _J = 125 °C |

Inh-Pulses shorter than the "minimum turn-on(off) input pulse width" are prolonged to 50ns (See Figure 7). Inh-Input doesn't have this feature.



Package Outline

6 Package Outline



Note: dimensions are given in mm.

6.1 Soldering Profile

The soldering profile qualified for 2ED020I06-FI (according to the standard IPC/JEDEC J-STD-020C) is moisture sensitivity level 3. The peak reflow temperature for its package (volume < 350 mm³) is 260 +0/-5 °C.

Diagrams

7 Diagrams

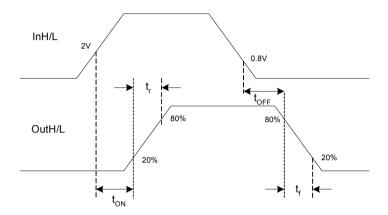


Figure 4 Switching Time Waveform Definition

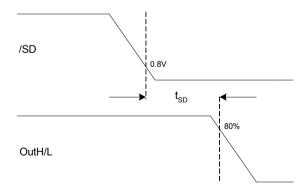
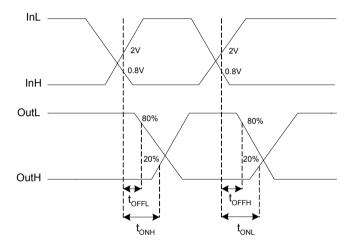


Figure 5 Shutdown Waveform Definition



Diagrams



 $\Delta t = max \; (|t_{ONH} - t_{OFFL}| \; , \; |t_{OFFH} - t_{ONL}|)$

Figure 6 Delay Matching Waveform Definitions

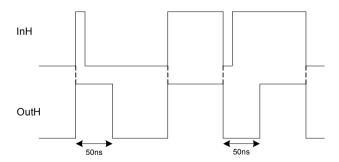


Figure 7 Short InH-Pulses Prolongation

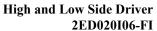


Application Advices

8 Application Advices

8.1 Power Supply

- a) The connection of a capacitor (>10nF) as close as possible to the supply pins VSH, VSL is recommended for avoiding that possible oscillations in the supply voltage can cause erroneous operation of the output driver stage. Total value of capacitance connected to the supply terminals has to be determined by taking into account gatecharge, peak current, supply voltage and kind of power supply.
- b) If a bootstrap power supply for the high side driver is applied, a resistor of 10Ω minimum in series with the bootstrap diode is required.





Application Advices

Total Quality Management

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